

**DATA SHEET** 

# SMP1304 Series: Low-Distortion Attenuator Plastic Packaged PIN Diodes

#### **Features**

- Low-distortion design
- Frequency range from HF to > 2 GHz
- Designed for base station applications
- · Configured for PI and TEE attenuators
- Available lead (Pb)-free and RoHS-compliant MSL-1 @ 260 °C<sup>(1)</sup> per JEDEC J-STD-020

# **Description**

The SMP1304 series of plastic packaged, surface mountable, low capacitance (0.3 pF), silicon PIN diodes is designed for use in attenuator applications from 5 MHz to beyond 2 GHz. The thick 100  $\mu m$  I region of these PIN diodes makes them very attractive for use in low-distortion PI and TEE attenuators commonly used in TV distribution applications. The 1 us typical carrier lifetime of these diodes results in resistance of 20  $\Omega$  maximum at 1 mA and 7  $\Omega$  maximum at 10 mA. Available in a selection of plastic packages: as a single diode in the small footprint SOD-323 package and in a variety of configurations in the SOT-23 package, including a low inductance (0.4 nH) SMP1304-007 package. Also available in the SOT-143 package are three diode junctions designed for insertion in TEE attenuators (SMP1304-018) and PI attenuators (SMP1304-019). Also available in a SOT-5 (SMP1304-027) package as a four-diode array designed for insertion in the commonly used four-diode PI attenuator circuit.



Skyworks offers lead (Pb)-free, RoHS (Restriction of Hazardous Substances)-compliant packaging.



# **Absolute Maximum Ratings**

Characteristic	Value			
Reverse voltage (V <sub>R</sub> )	200 V			
Power dissipation @ 25 °C lead temperature (P <sub>D</sub> )	250 mW			
Storage temperature (T <sub>ST</sub> )	-65 °C to +150 °C			
Operating temperature (T <sub>OP</sub> )	-65 °C to +150 °C			
ESD human body model	Class 1C			

Performance is guaranteed only under the conditions listed in the specifications table and is not guaranteed under the full range(s) described by the Absolute Maximum specifications. Exceeding any of the absolute maximum/minimum specifications may result in permanent damage to the device and will void the warranty.

CAUTION: Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

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# H				<b>□</b>	¥ 4 4	
Single	Common Cathode	Series Pair	Low Inductance	Single	PI	PI
S0T-23	S0T-23	S0T-23	S0T-23	S0D-323	S0T-143	SOT-5
<b>SMP1304-001</b> Marking: PG1	SMP1304-004 Marking: PG3	SMP1304-005 Marking: PG2	SMP1304-007 Marking: PGB	◆SMP1304-011 Marking: PG	SMP1304-019 Marking: PGJ	SMP1304-027 Marking: PGM
SMP1304-001LF Marking: RG1	SMP1304-004LF Marking: RG3	SMP1304-005LF Marking: RG2	SMP1304-007LF Marking: RGB	◆SMP1304-011LF Marking: RG	SMP1304-019LF Marking: RGJ	SMP1304-027LF Marking: RGM
L <sub>S</sub> = 1.5 nH	L <sub>S</sub> = 1.5 nH	L <sub>S</sub> = 1.5 nH	$L_S = 0.4 \text{ nH}$	L <sub>S</sub> = 1.5 nH		



LF denotes lead (Pb)-free, RoHS-compliant packaging option as an alternative to our standard tin/lead (Sn/Pb) packaging.



Innovation to  $\mathbf{Go}^{\mathsf{TM}}$ 

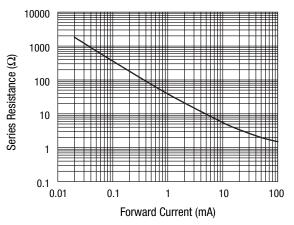
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# **Electrical Specifications at 25 °C**

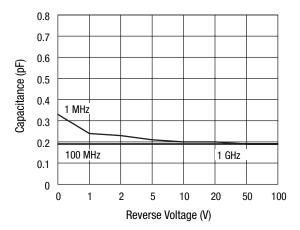
Parameter	Condition	Тур.	Max.	Unit	
Reverse current (I <sub>R</sub> )	V <sub>R</sub> = 200 V		10	μА	
Capacitance (C <sub>T</sub> ) <sup>(1)</sup>	F = 1 MHz, V = 30 V		0.3	pF	
Resistance (R <sub>S</sub> )	F = 100 MHz, I = 1 mA	40	50	Ω	
Resistance (R <sub>S</sub> )	F = 100 MHz, I = 10 mA		7	Ω	
Resistance (R <sub>S</sub> )	F = 100 MHz, I = 100 mA		2	Ω	
Forward voltage (V <sub>F</sub> )	I <sub>F</sub> = 10 mA	0.8		V	
Carrier lifetime (TI)	I <sub>F</sub> = 10 mA	1		μs	
I region width		100		μm	

<sup>1.</sup> The SMP1304-019 and SMP1304-027 maximum capacitance is 0.45 pF.

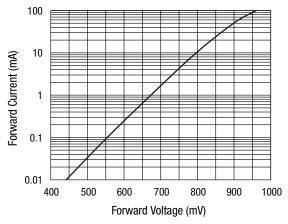
# **Typical Performance Data**



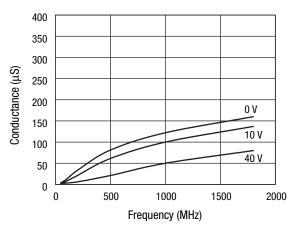
## Series Resistance vs. Current @ 100 MHz



Capacitance vs. Reverse Voltage



**DC Characteristic** 



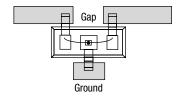
Conductance vs. Frequency and Reverse Voltage

# Resistance vs. Temperature @ 100 MHz

I <sub>F</sub> (mA)	R -55 °C (Ω)	R -15 °C (Ω)	R 25 °C (Ω)	R 65 °C (Ω)	R 100 °C (Ω)
0.02	1590	1660	1752	1770	1760
0.1	315	340	367	396	409
0.3	108	118	128	141	147
1	34.5	37.9	41.6	46.3	48.8
10	4.8	5.3	5.8	6.6	7
20	3	3.3	3.6	4.1	4.3
100	1.3	1.4	1.5	1.7	1.8

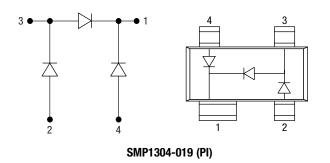
#### SMP1304-007

In the -007 configuration of the S0T-23 package, the package inductance is effectively reduced to 0.4 nH, in comparison to the 1.5 nH value of the standard configuration. This lower inductance will be particularly beneficial when the diodes are used as shunt connected switches at frequencies higher than 500 MHz, where inductance is the primary limitation on maximum switch isolation. To achieve the effective 0.4 nH, the S0T-23 package must be inserted in the microstrip circuit board with a gap in the trace, as shown in the figure. Because of the polarity of the diode junction, this low inductance feature is realizable only with the cathode connected to ground.



#### **SMP1304-019 PI Attenuator PIN Diodes**

The SMP1304-019 employs three PIN diode junctions in a SOT-143 package. They are configured for ease of insertion in PI attenuator circuits commonly used from 10 MHz to beyond 1 GHz. The SMP1304 PIN diode junction was designed for low capacitance, wide resistance dynamic range, and low distortion performance.



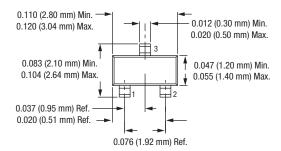
#### **Recommended Solder Reflow Profiles**

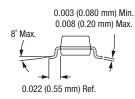
Refer to the "<u>Recommended Solder Reflow Profile</u>" Application Note.

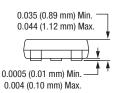
# **Tape and Reel Information**

Refer to the "<u>Discrete Devices and IC Switch/Attenuators</u> Tape and Reel Package Orientation" Application Note.

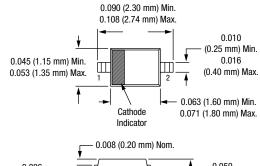
## **SOT-23**

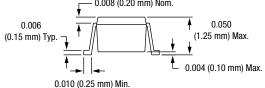




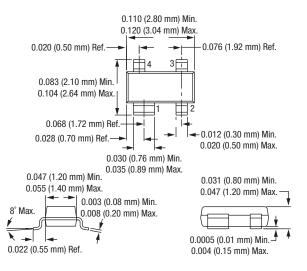


#### SOD-323

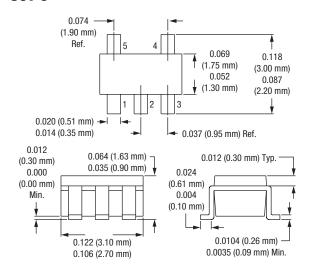




#### S0T-143



### **SOT-5**



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